

L Number	Hits	Search Text	DB	Time stamp
-	905	(313/495).CCLS.	USPAT; US-PGPUB	2004/01/30 18:00
-	109	ando-yoichi.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/07/16 12:45
-	2	hyperspeed.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/30 15:32
-	1	lightspeed.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/30 15:33
-	10	hyper same antenna.ti.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/30 15:33
-	32	ando-yoichi.in. and image adj forming	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/11/03 11:49
-	984	(313/495).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 09:41
-	905	(313/495).CCLS.	USPAT; US-PGPUB	2003/01/31 09:42
-	360	(313/496).CCLS.	USPAT; US-PGPUB	2003/01/31 11:28
-	0	("l18 not l15").PN.	USPAT; US-PGPUB	2003/01/31 09:42
-	444	"l28" not ((313/495).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 09:42
-	200	((313/496).CCLS.) not ((313/495).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 10:40
-	2	5903108.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:06
-	0	806788.URPN.	USPAT	2003/01/31 10:40
-	162	pixtech.as.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:01
-	299279	5903108.pn. spacer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:06
-	1	5903108.pn. and spacer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:16

-	0	5463276.pn. and image	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:16
-	4	5463276.pn. 4899081.pn.5270613.pn. and image	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:17
-	1	(5463276.pn. 4899081.pn. 5270613.pn.) and image	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:17
-	1105	((313/496) or (313/495)).CCLS.	USPAT; US-PGPUB	2003/01/31 11:28
-	755	(313/493).CCLS.	USPAT; US-PGPUB	2003/01/31 11:28
-	0	("198 not 195").PN.	USPAT; US-PGPUB	2003/01/31 11:28
-	729	((313/493).CCLS.) not ((313/496) or (313/495)).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:30
-	193	((313/493).CCLS.) not ((313/496) or (313/495)).CCLS.) and display	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:30
-	80	((313/493).CCLS.) not ((313/496) or (313/495)).CCLS.) and display and image	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:37
-	939	(313/634).CCLS.	USPAT; US-PGPUB	2003/01/31 11:42
-	5	("5508584" "5543691" "5561345" "5614781" "5670296").PN.	USPAT	2003/01/31 11:37
-	1	5903108.URPN.	USPAT	2003/01/31 11:40
-	1834	((313/493) or (313/495) or (313/496)).CCLS.	USPAT; US-PGPUB	2003/01/31 11:43
-	0	("1125 not 1130").PN.	USPAT; US-PGPUB	2003/01/31 11:43
-	728	((313/634).CCLS.) not ((313/493) or (313/495) or (313/496)).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:43
-	46	((313/634).CCLS.) not ((313/493) or (313/495) or (313/496)).CCLS.) and image and (forming display)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/01/31 11:43
-	1768	((313/495) or (313/496) or (313/493)).CCLS.	USPAT	2003/07/16 15:25
-	211	((313/495) or (313/496) or (313/493)).CCLS.	US-PGPUB	2003/07/16 13:14
-	1	5770918.pn.	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/16 15:26
-	1	5770918.pn. and 403b	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/16 15:31
-	1	6114804.pn.	USPAT; US-PGPUB; EPO; JPO; IBM TDB	2003/07/16 15:31

-	1	6114804.pn. and "14"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:40
-	1	20020005692.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:19
-	0	20020005692.did. and conductive adj layer	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:40
-	1	20020005692.did. and conductive adj film	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:43
-	1	20020005692.did. and conductive adj film near4 "5"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:58
-	1	5903108.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:47
-	1	5903108.pn. and spacer	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:47
-	1	20020005692.did. and conductive adj film near4 "14"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:15
-	1	5903108.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:15
-	1	5903108.pn. and track	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:18
-	1	5903108.pn. and (track ring) with material	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:33
-	1	20020005692.did. and 27B	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:33
-	1	20020005692.did. and longitudinal	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:34
-	1	20020005692.did. and longitudinal with end same discharge	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:35
-	1	20020005692.did. and longitudinal with end same suppressing	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:36
-	1	20020005692.did. and longitudinal with end	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:06
-	1	20020005692.did. and conductive adj film with "5" same surface	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:19
-	1	5903108.pn. and spacer	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:23

-	1	5903108.pn. and (ring track) same (film coat\$ layer\$4)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:30
-	0	5903108.pn. and (closed adj loop)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:34
-	1	5903108.pn. and bias\$4	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:34
-	1	5903108.pn. and bias\$4 same (track ring)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:36
-	1	5903108.pn. and bias\$4 same (track ring) same cathode	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:06
-	79	jones-gary-w.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	34	jones-gary-w.in. and zimmerman-steven-m.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	1	6169358.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	1	6169358.pn. and "240"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:18
-	0	20020005692.did. and "14"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:18
-	1	20020005692.did. and second adj conductive adj film	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:56
-	1	5903108.URPN.	USPAT	2003/07/16 18:56
-	2584	anode same (surround ring encircle circle) and (image display panel)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:59
-	17	((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:15
-	17	((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:01
-	17	((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:14
-	262	((surround\$5 ring encircle circl\$4) with (anode electrode) same (conducting conductive metallic) near3 (film coat layer) and substrate and image and (display panel image).ab,ti.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:17

-	60	(surround\$5 ring encircle circl\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not (((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:20
-	60	(surround\$5 ring encircle circl\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and ((surround\$5 ring encircle circl\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not (((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:21
-	10	(surround\$5 ring encircle circl\$4) near4 (phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic) near3 (film coat layer) and ((surround\$5 ring encircle circl\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not (((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:23
-	14	(surround\$5 ring encircle circl\$4) near4 (phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not (((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:24
-	14	(surround\$5 ring encircle circl\$4) near4 (phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not (((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:25

-	14	(surround\$5 ring encircle circl\$4) near4 (phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and ((surround\$5 ring encircle circl\$4) near4 (phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not (((surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circl\$4) with (image with (display panel)) same (conducting conductive metallic) near3 (film coat layer)))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:46
-	72	guard adj ring near6 anode	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:47
-	0	guard adj ring near6 anode and image and (display panel).ab,ti.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:47
-	1	guard adj ring near13 anode and image and (display panel).ab,ti.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:47
-	1	5945969.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:25
-	0	5945969.pn. and frame	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:25
-	1	5945969.pn. and support	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:26
-	0	5945969.pn. and (joint frit)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:27
-	1	5945969.pn. and (edge)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:27
-	13	ando-yoichi.in. and emitter	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/17 11:47
-	5	ando-yoichi.in. and emitter and (surround\$4 encircl\$4 circl\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/31 18:57
-	5	ando-yoichi.in. and emitter and (surround\$4 encircl\$4 circl\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/17 11:50
-	8	(ando-yoichi.in. and emitter) not (ando-yoichi.in. and emitter and (surround\$4 encircl\$4 circl\$4))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/07/17 11:50
-	1	6509691.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:12

-	0	6509691.pn. and (surround\$5).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:12
-	0	6509691.pn. and (encircl\$4 circl\$4).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
-	1	20030102798.did. and (surround\$4 encircl\$4 circl\$4).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
-	1	20030102798.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 13:20
-	1	20030102798.did. and surround\$4	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:47
-	1	20030102798.did. and (apart from)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:59
-	0	5903108.pn. and "33"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:59
-	1	5903108.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 13:15
-	290	serigraphy	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 13:16
-	0	20030102798.did. and second adj conductive adj film	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 13:20
-	1	20030102798.did. and "14"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 13:20
-	1	20020005692.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 13:21
-	1	20020005692.did. and second adj conductive adj film	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 14:17
-	1	20020005692.did. and face adj plate.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 14:18
-	5	ando-yoichi.in. and emitter and (surround\$4 encircl\$4 circl\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/10/31 18:58
-	0	2002000569.did. and (closed adj loop).clm. and (lower adj potential).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/31 19:00
-	0	2002000569.did. and (closed adj loop).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/31 19:00

-	0	2002000569.did. and (loop).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/31 19:00
-	1	2002000569.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/31 19:00
-	0	20020005692.did. and (closed adj loop).clm. and (lower adj potential).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/31 19:00
-	1	20020005692.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/10/31 19:00
-	118	ando-yoichi.in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 12:13
-	2	20020005692.did.	US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/11/03 12:13
-	1	20020005692.did.	US-PGPUB; EPO; JPO; IBM_TDB	2003/11/03 12:13
-	0	20020005692.did. and phosphor.c	US-PGPUB; EPO; JPO; IBM_TDB	2003/11/03 12:14
-	1	20020005692.did. and phosphor.clm.	US-PGPUB; EPO; JPO; IBM_TDB	2003/11/03 12:14
-	0	20020005692.did. and overlapp\$4.clm.	US-PGPUB; EPO; JPO; IBM_TDB	2003/11/03 12:14
-	1	20020005692.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/11/21 11:22
-	1	5903108.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/11/21 11:22
-	1	20020005692.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/30 18:04
-	255	(313/495,496,497).CCLS.	US-PGPUB	2004/01/30 18:14
-	1294	(313/495,496,497).CCLS.	USPAT	2004/01/30 18:34
-	753	(315/169.4).CCLS.	USPAT	2004/01/30 18:34
-	148	(345/75.2).CCLS.	USPAT; US-PGPUB	2004/01/30 18:43
-	103	(345/75.1).CCLS.	USPAT; US-PGPUB	2004/01/30 18:45
-	2	6509691.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/30 19:14
-	1	6509691.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/30 19:14
-	0	6509691.pn. and (circle surround\$7 encircle).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/30 19:16

-	1	6509691.pn. and potential adj supplying	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/30 19:17
-	1	6509691.pn. and potential adj supplying and (surround\$6 encircl\$5 circl\$5)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/30 19:21
-	1	6509691.pn. and around.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/30 19:24
-	0	6509691.pn. and frame.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/30 19:25
-	0	6509691.pn. and support.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/30 19:25
-	1	20030137235.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 16:46
-	1	20030137235.did. and (high adj voltage "18")	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 16:49
-	1	20030137235.did. and (high adj voltage "18") same (periph\$5 surround\$5 around)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 16:56
-	1	20020005692.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:03
-	1	20020005692.did. and (image adj forming adj member first adj conductive adj film) with (potential voltage volt)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:04
-	1	20020005692.did. and (image adj forming adj member first adj conductive adj film) with (potential voltage volt)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:10
-	119	ando-yoichi.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:10
-	119	ando-yoichi.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:11
-	57	ando-yoichi.in. and image	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:11
-	12	ando-yoichi.in. and image and electron and (surround\$6 around peripher\$8)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:11
-	32	ando-yoichi.in. and image and electron	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:19
-	29358	canon-kabushiki-kaisha.as.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:19
-	485	canon-kabushiki-kaisha.as. and image and electron near4 (emit emitter emission)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:19

-	480	canon-kabushiki-kaisha.as. and image and electron near4 (emit emitter emission) not ando-yoichi.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:20
-	505	canon-kabushiki-kaisha.as. and (display image) and electron near4 (emit emitter emission) not ando-yoichi.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:20
-	409	(canon-kabushiki-kaisha.as. and (display image) and electron near4 (emit emitter emission) not ando-yoichi.in.) and (peripher\$7 surround\$6 around circl\$7)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 17:25
-	409	(canon-kabushiki-kaisha.as. and (display image) and electron near4 (emit emitter emission) not ando-yoichi.in.) and (peripher\$7 surround\$6 around circl\$7)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/01/31 18:10
-	1	6486610.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:14
-	1	6486610.pn. and high adj resistance	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:14
-	0	6486610.pn. and high adj resistance.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:14
-	0	6486610.pn. and low adj resistance.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:14
-	0	6486610.pn. and low.clm. adj resistance.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:14
-	1	6486610.pn. and film.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:21
-	1	6486610.pn. and (potential voltage volt).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:22
-	1	6486610.pn. and (potential voltage volt).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:23
-	1	6486610.pn. and (ground 3kv).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:27
-	1	6486610.pn. and around.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:28
-	1	6486610.pn. and (image display).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:29
-	302506	6486610.pn. and (image display).clm. around.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:29
-	1	6486610.pn. and (image display).clm. and around.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:30

-	1	6486610.pn. and (image display).clm. and around.clm. and potential.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:38
-	1	6486610.pn. and film.clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:33
-	11	("4769575" "4904895" "5066883" "5528099" "5569974" "5682085" "5770918" "5905335" "6124671" "6267636" "6278233") .PN.	USPAT	2004/01/31 18:33
-	1	20030168991.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2004/01/31 18:40